

**PATENT ASSIGNMENT**

Electronic Version v1.1  
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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
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<b>NATURE OF CONVEYANCE:</b>	RELEASE BY SECURED PARTY
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<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Dana Global Holdings, Inc.	12/06/2005

<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	American Electronic Components, Inc.
<b>Street Address:</b>	23590 County Road 6
<b>City:</b>	Elkhart
<b>State/Country:</b>	INDIANA
<b>Postal Code:</b>	46515

<b>PROPERTY NUMBERS Total: 24</b>	
<b>Property Type</b>	<b>Number</b>
Patent Number:	5497081
Patent Number:	5504424
Patent Number:	6064198
Patent Number:	6285958
Patent Number:	6340884
Patent Number:	4970463
Patent Number:	6198275
Patent Number:	5719496
Patent Number:	5757181
Patent Number:	5818223
Patent Number:	5332965
Application Number:	09653507
Application Number:	09853771
Application Number:	09912359
Application Number:	09912908

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Application Number:	09912953
Application Number:	09957840
Application Number:	10057374
Application Number:	10081573
Application Number:	60332590
Application Number:	60332649
Application Number:	60333260
Application Number:	60369447
Application Number:	60381008

**CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	560255-155127
NAME OF SUBMITTER:	James R. Mix

**Total Attachments: 12**

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**TERMINATION AND RELEASE OF SECURITY INTEREST  
IN PATENTS**

TERMINATION AND RELEASE OF SECURITY INTEREST IN PATENTS (as amended, restated, supplemented or otherwise modified from time to time, this "**Agreement**"), dated as of December 9, 2005, from DANA GLOBAL HOLDINGS, INC. (the "**Secured Party**"), to AMERICAN ELECTRONIC COMPONENTS, INC. (the "**Assignor**").

**WITNESSETH:**

WHEREAS, pursuant to that certain Collateral Assignment of Patents and Security Agreement, dated as of November 15, 2002, in favor of the Secured Party (the "**Security Agreement**"), a security interest (the "**Security Interest**") was granted by the Assignor to the Secured Party in certain Collateral (as hereinafter defined); and

WHEREAS, the Security Interest was recorded in the Patent Division of the United States Patent and Trademark Office (the "**USPTO**"); and

WHEREAS, the Secured Party now desires to terminate and release the entirety of its Security Interest in the Collateral.

NOW, THEREFORE, for good and valuable consideration, including the satisfaction of all obligations, indebtedness and liabilities of the Assignor secured by the Collateral pursuant to the Security Agreement, the receipt and adequacy of which are hereby acknowledged, and upon the terms set forth in this Agreement, the parties hereto agree as follows:

1. **Release.** The Secured Party hereby terminates and releases the Security Interest in the Collateral and hereby transfers and assigns to Assignor all of its right, title and interest in and to the Collateral.

2. **Collateral.** The term "**Collateral**," as used herein, shall mean all of the Assignor's right, title and interest of every kind and nature in and to the following:

(i) all letters patent issued by the USPTO (including, without limitation, those listed on Schedule A to this Agreement); (ii) all applications for letters patent to be issued by the USPTO (including, without limitation, those listed on Schedule A to this Agreement); (iii) all letters patent issued by any other country or any office, agency or other governmental authority thereof; (iv) all applications for letters patent to be issued by any office, agency or other governmental authority referred to in clause (ii) above; (v) all registrations and recordings with respect to any of the foregoing; (vi) all reissues, continuations, continuations-in-part, extensions and divisions of any of the foregoing; (vii) all licenses and other agreements relating in whole or in part to any patents, inventions, processes, production methods, proprietary information or know-how covered by any of the foregoing, including all rights to payments in respect thereof; (viii) all rights to sue for past, present or future infringements of any of the foregoing; (ix) all goodwill related to any of the foregoing; (x) to the extent not included above, all general intangibles (as such term is defined in the Uniform Commercial Code of the State of Ohio) of the Assignor

related to the foregoing; and (xi) all proceeds of any and all of the foregoing (including license royalties, rights to payment, accounts and proceeds of infringement suits) and, to the extent not otherwise included, all payments under insurance (whether or not Secured Party is the loss payee thereof) or any indemnity, warranty or guaranty payable by reason of loss or damage to or otherwise with respect to the foregoing Collateral.

3. Further Assurance. The Secured Party hereby agrees to duly execute, acknowledge, procure and deliver any further documents and to do such other acts as may be reasonably necessary to effect the release of the Security Interest contemplated hereby.

**[Signatures follow.]**

IN WITNESS WHEREOF, the undersigned has executed this Agreement by its duly authorized officer as of the date first above written.

DANA GLOBAL HOLDINGS, INC.  
as Secured Party

By: *Rodney R. Filcek*  
Name: *Rodney R. Filcek*  
Title: *President*

STATE OF *Ohio* )  
COUNTY OF *Lucas* ) ss:

On this *6th* day of December, 2005, before me personally appeared *Rodney R. Filcek* to me known who, being by me duly sworn, did depose and say that he/she is *President* of Dana Global Holdings, Inc., the institution described herein and which executed the foregoing instrument, and that he/she signed his name thereto pursuant to the authority granted by Dana Global Holdings, Inc.



LINDA M. GRANT  
Notary Public, State of Ohio  
My Commission Expires 10/26/2009

*Linda M. Grant*  
Notary Public

**SCHEDULE A**  
**TO TERMINATION AND RELEASE OF**  
**SECURITY INTEREST IN PATENTS**

**PATENTS ISSUED**

Case No.	Title	Country	Status	Serial No.	Filing Date	Patent No	Issue Date
5001	DUAL-ELEMENT PROXIMITY SENSOR FOR SENSING THE DIRECTION OF ROTATION OF A FERROUS TARGET WHEEL	US	Granted	485561	06/07/1995	5719496	02/17/1998
5002	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR	DE	Granted	29623568.7	06/06/1996	29623568.7	10/01/1998
5002	MECHANICALLY ADJUSTABLE LINEAR OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR	DE	Granted	93110001	06/22/1993	575971	02/12/1997
5002	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR	EP	Granted	93110001	06/22/1993	575971	02/12/1997
5002	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR	FR	Granted	93110001	06/22/1993	575971	02/12/1997

Case No.	Title	Country	Status	Serial No.	Filing Date	Patent No	Issue Date
5002	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR	GB	Granted	9311001	06/22/1993	575971	02/12/1997
5002	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR	US	Granted	902075	06/22/1992	5332965	07/26/1994
5002	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR	US	Granted	08/051412	04/28/1993	5497081	03/05/1996
5002	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR	US	Granted	486650	06/07/1995	5757181	05/26/1998
5002	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR	US	Granted	649987	05/17/1996	5818223	10/16/1998
5002	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A	US	Granted	3774	01/07/1998	6198275	03/06/2001

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Case No.	Title	Country	Status	Serial No.	Filing Date	Patent No	Issue Date
	LINEAR DISPLACEMENT SENSOR						
	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR	US	Granted	09/599321	06/22/2000	6340884	01/22/2002
5002	TEMPERATURE STABLE PROXIMITY SENSOR WITH SENSING OF FLUX EMANATING FROM THE LATERAL SURFACE OF A MAGNET	DE	Granted	90104717.5	03/13/1990	387781	06/08/1994
5003	TEMPERATURE STABLE PROXIMITY SENSOR WITH SENSING OF FLUX EMANATING FROM THE LATERAL SURFACE OF A MAGNET	EP	Granted	90104717.5	03/13/1990	387781	06/08/1994
5003	TEMPERATURE STABLE PROXIMITY SENSOR WITH SENSING OF FLUX EMANATING FROM THE LATERAL SURFACE OF A MAGNET	FR	Granted	90104717.5	03/13/1990	387781	06/08/1994
5003	TEMPERATURE STABLE PROXIMITY SENSOR WITH SENSING OF FLUX EMANATING FROM THE LATERAL SURFACE OF A MAGNET	GB	Granted	90104717.5	03/13/1990	387781	06/08/1994
5003	TEMPERATURE STABLE PROXIMITY SENSOR WITH SENSING OF FLUX EMANATING FROM THE LATERAL SURFACE OF A MAGNET	JP	Granted	02-062470	03/13/1990	2898687	03/12/1999
5003	TEMPERATURE STABLE PROXIMITY SENSOR WITH SENSING OF FLUX EMANATING FROM THE LATERAL SURFACE OF A MAGNET	US	Granted	322518	03/13/1989	4970463	11/13/1990
5004	GEAR TOOTH SENSOR WITH IMPROVED RESOLUTION AND STABILITY	US	Granted	08/911175	08/14/1997	6064198	05/16/2000
5005	VARIABLE RELUCTANCE SENSOR	US	Granted	08/070083	05/28/1993	5504424	04/02/1996

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Case No.	Title	Country	Status	Serial No.	Filing Date	Patent No	Issue Date
5006	UTILIZING A MAGNETIC BOBBIN ELECTRONIC CIRCUIT FOR AUTOMATIC COMPENSATION OF A SENSOR OUTPUT SIGNAL	US	Granted	09/023136	02/12/1998	6285958	09/04/2001

PATENTS PENDING

Case No.	Title	Country	Status	Serial No.	Filing Date	Patent No	Issue Date
5002	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR	CA	Pending	2316924	07/31/1998		
5002	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR	EP	Pending	96918052	06/05/1996		
5002	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR	EP	Pending	98937326.1	07/31/1998		
5002	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR	JP	Pending	150844/93	06/22/1993		
5002	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR	JP	Pending	501263/97	06/05/1996		
5002	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR	JP	Pending	2000-527807	07/31/1998		

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Case No.	Title	Country	Status	Serial No.	Filing Date	Patent No	Issue Date
	POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR						
	MECHANICALLY ADJUSTABLE LINEAR-OUTPUT ANGULAR POSITION SENSOR ELECTRONIC CIRCUIT FOR AUTOMATIC DC OFFSET COMPENSATION FOR A LINEAR DISPLACEMENT SENSOR						
5002	LINEAR DISPLACEMENT SENSOR	US	Pending	09/853771	05/11/2001		
	GEAR TOOTH SENSOR WITH IMPROVED RESOLUTION AND STABILITY						
5004		EP	Pending	96924680	07/22/1996		
	ELECTRONIC CIRCUIT FOR AUTOMATIC COMPENSATION OF A SENSOR OUTPUT SIGNAL						
5006		AU	Pending	9886838	07/31/1998		
	ELECTRONIC CIRCUIT FOR AUTOMATIC COMPENSATION OF A SENSOR OUTPUT SIGNAL						
5006		CA	Pending	2320484	07/31/1998		
	ELECTRONIC CIRCUIT FOR AUTOMATIC COMPENSATION OF A SENSOR OUTPUT SIGNAL						
5006		EP	Pending	98938271.8	07/31/1998		
	ELECTRONIC CIRCUIT FOR AUTOMATIC COMPENSATION OF A SENSOR OUTPUT SIGNAL						
5006		EP	Pending	96918052	06/05/1996		
	ELECTRONIC CIRCUIT FOR AUTOMATIC COMPENSATION OF A SENSOR OUTPUT SIGNAL						
5006		JP	Pending	2000531708	07/31/1998		
	ELECTRONIC CIRCUIT FOR AUTOMATIC COMPENSATION OF A SENSOR OUTPUT SIGNAL						
5006		WO	Pending	US98/16076	07/31/1998		
	ROTARY POSITION SENSOR (WITH FORD GLOBAL TECHNOLOGY)						
5558		US	Pending	09/653507	09/12/2000		
	ROTARY POSITION SENSOR (WITH FORD GLOBAL TECHNOLOGY)						
5558		WO	Pending	US01/27103	08/31/2001		

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Case No.	Title	Country	Status	Serial No.	Filing Date	Patent No	Issue Date
5566	TRANSMISSION SHIFT POSITION SENSOR	US	Pending	09/957840	09/21/2001		
5566	TRANSMISSION SHIFT POSITION SENSOR (WITH FORD GLOBAL TECHNOLOGY)	US	Pending	10/081573	02/22/2002		
5566	TRANSMISSION SHIFT POSITION SENSOR	WO	Pending	US02/29925	09/20/2002		
5915	MECHANICAL DESIGN FOR ANTI-ICE LOCK CONDITION - RH SENSOR	CA	Pending	2394916	07/24/2002		
5915	MECHANICAL DESIGN FOR ANTI-ICE LOCK CONDITION - RH SENSOR	EP	Pending	206328.3	07/25/2002		
5915	MECHANICAL DESIGN FOR ANTI-ICE LOCK CONDITION - RH SENSOR	MX	Pending	2007278	07/25/2002		
5915	MECHANICAL DESIGN FOR ANTI-ICE LOCK CONDITION - RH SENSOR	US	Pending	09/912908	07/25/2001		
5916	MECHANICAL LINKAGE ASSEMBLY FOR RH SENSOR	CA	Pending	2394605	07/24/2002		
5916	MECHANICAL LINKAGE ASSEMBLY FOR RH SENSOR	DE	Pending	10233432.5	07/25/2002		
5916	MECHANICAL LINKAGE ASSEMBLY FOR RH SENSOR	MX	Pending	2007276	07/25/2002		
5916	MECHANICAL LINKAGE ASSEMBLY FOR RH SENSOR	US	Pending	09/912359	07/25/2001		
5917	SELF LUBRICATING BEARING FOR UNDERBODY AUTOMOTIVE APPLICATION	CA	Pending		07/24/2002		
5917	SELF LUBRICATING BEARING FOR UNDERBODY AUTOMOTIVE APPLICATIONS	EP	Pending				
5917	SELF LUBRICATING BEARING FOR UNDERBODY AUTOMOTIVE APPLICATIONS	MX	Pending				
5917	SELF LUBRICATING BEARING FOR UNDERBODY AUTOMOTIVE APPLICATIONS	US	Pending	09/912953	07/25/2001		

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Case No.	Title	Country	Status	Serial No.	Filing Date	Patent No	Issue Date
5917	SELF LUBRICATING BEARING FOR UNDERBODY AUTOMOTIVE APPLICATIONS	US	Pending	60/369447	04/02/2002		
5921	FREQUENCY COMPENSATION FOR ROTATING TARGET SENSOR	US	Pending	10/057374	01/25/2002		
6390	MINIATURE SENSOR PACKAGE WITH MAGNETIC RESIN	US	Pending	60/332649	11/05/2001		
6391	MINIATURE SENSOR PACKAGE WITH MAGNETIC RESIN	US	Pending	60/333260	11/05/2001		
6392	MINIATURE SENSOR PACKAGE	US	Pending	60/332590	11/05/2001		
6652	THROUGH HOLE ROTARY SENSOR	US	Pending	60/381008	05/15/2002		

**UNFILED PATENTS**

Case No.	Title	Country	Status	Serial No.	Filing Date	Patent No	Issue Date
5721	LINEAR PRESSURE SENSING MAGNETIC CIRCUIT/PACKAGE	US	Unfiled				
6496	WHEEL SPEED SENSOR	US	Unfiled				
6590	CONTOUR COUPLED ROTATING MAGNET SWITCHED POLARITY WHEEL SPEED SENSOR	US	Unfiled				